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# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	360
Number of Logic Elements/Cells	2880
Total RAM Bits	40960
Number of I/O	102
Number of Gates	199000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep1k50tc144-2n

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

- Software design support and automatic place-and-route provided by Altera development systems for Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations
- Flexible package options are available in 100 to 484 pins, including the innovative FineLine BGA<sup>TM</sup> packages (see Tables 2 and 3)
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), DesignWare components, Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, VeriBest, and Viewlogic

Table 2. ACEX	1K Package Option	ns & I/O Pin Count	Notes (1), (2)		
Device	100-Pin TQFP	144-Pin TQFP	208-Pin PQFP	256-Pin FineLine BGA	484-Pin FineLine BGA
EP1K10	66	92	120	136	136 (3)
EP1K30		102	147	171	171 (3)
EP1K50		102	147	186	249
EP1K100			147	186	333

#### Notes:

- ACEX 1K device package types include thin quad flat pack (TQFP), plastic quad flat pack (PQFP), and FineLine BGA packages.
- (2) Devices in the same package are pin-compatible, although some devices have more I/O pins than others. When planning device migration, use the I/O pins that are common to all devices.
- (3) This option is supported with a 256-pin FineLine BGA package. By using SameFrame<sup>TM</sup> pin migration, all FineLine BGA packages are pin-compatible. For example, a board can be designed to support 256-pin and 484-pin FineLine BGA packages.

Table 3. ACEX 1K F	Table 3. ACEX 1K Package Sizes											
Device	100-Pin TQFP	144-Pin TQFP	208-Pin PQFP	256-Pin FineLine BGA	484-Pin FineLine BGA							
Pitch (mm)	0.50	0.50	0.50	1.0	1.0							
Area (mm²)	256	484	936	289	529							
$\begin{array}{c} \text{Length} \times \text{width} \\ \text{(mm} \times \text{mm)} \end{array}$	16×16	22 × 22	30.6 × 30.6	17 × 17	23 × 23							



For more information on the configuration of ACEX 1K devices, see the following documents:

- Configuration Devices for ACEX, APEX, FLEX, & Mercury Devices Data Sheet
- MasterBlaster Serial/USB Communications Cable Data Sheet
- ByteBlasterMV Parallel Port Download Cable Data Sheet
- BitBlaster Serial Download Cable Data Sheet

ACEX 1K devices are supported by Altera development systems, which are integrated packages that offer schematic, text (including AHDL), and waveform design entry, compilation and logic synthesis, full simulation and worst-case timing analysis, and device configuration. The software provides EDIF 2 0 0 and 3 0 0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools.

The Altera software works easily with common gate array EDA tools for synthesis and simulation. For example, the Altera software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the Altera software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the Altera development system includes DesignWare functions that are optimized for the ACEX 1K device architecture.

The Altera development systems run on Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations.



For more information, see the MAX+PLUS II Programmable Logic Development System & Software Data Sheet and the Quartus Programmable Logic Development System & Software Data Sheet.

# Functional Description

Each ACEX 1K device contains an enhanced embedded array that implements memory and specialized logic functions, and a logic array that implements general logic.

The embedded array consists of a series of EABs. When implementing memory functions, each EAB provides 4,096 bits, which can be used to create RAM, ROM, dual-port RAM, or first-in first-out (FIFO) functions. When implementing logic, each EAB can contribute 100 to 600 gates towards complex logic functions such as multipliers, microcontrollers, state machines, and DSP functions. EABs can be used independently, or multiple EABs can be combined to implement larger functions.

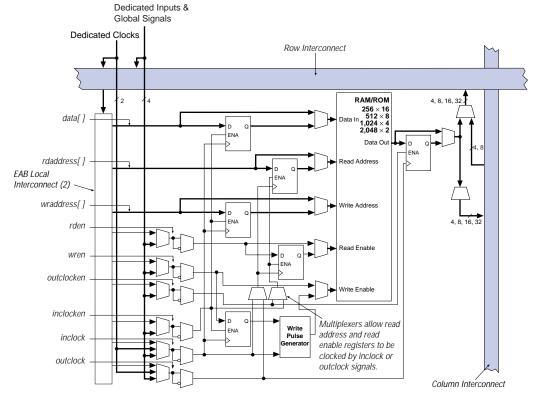


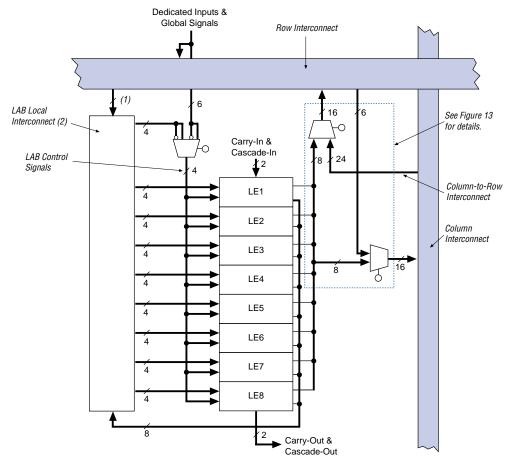
Figure 2. ACEX 1K Device in Dual-Port RAM Mode Note (1)

#### Notes:

- (1) All registers can be asynchronously cleared by EAB local interconnect signals, global signals, or the chip-wide reset.
- (2) EP1K10, EP1K30, and EP1K50 devices have 88 EAB local interconnect channels; EP1K100 devices have 104 EAB local interconnect channels.

The EAB can use Altera megafunctions to implement dual-port RAM applications where both ports can read or write, as shown in Figure 3. The ACEX 1K EAB can also be used in a single-port mode (see Figure 4).

Figure 7. ACEX 1K LAB



## Notes:

- (1) EP1K10, EP1K30, and EP1K50 devices have 22 inputs to the LAB local interconnect channel from the row; EP1K100 devices have 26.
- (2) EP1K10, EP1K30, and EP1K50 devices have 30 LAB local interconnect channels; EP1K100 devices have 34.

## LE Operating Modes

The ACEX 1K LE can operate in the following four modes:

- Normal mode
- Arithmetic mode
- Up/down counter mode
- Clearable counter mode

Each of these modes uses LE resources differently. In each mode, seven available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. Three inputs to the LE provide clock, clear, and preset control for the register. The Altera software, in conjunction with parameterized functions such as LPM and DesignWare functions, automatically chooses the appropriate mode for common functions such as counters, adders, and multipliers. If required, the designer can also create special-purpose functions that use a specific LE operating mode for optimal performance.

The architecture provides a synchronous clock enable to the register in all four modes. The Altera software can set DATA1 to enable the register synchronously, providing easy implementation of fully synchronous designs.

Figure 11 shows the ACEX 1K LE operating modes.

#### Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a 4-input LUT. The compiler automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. Either the register or the LUT can be used to drive both the local interconnect and the FastTrack Interconnect routing structure at the same time.

The LUT and the register in the LE can be used independently (register packing). To support register packing, the LE has two outputs; one drives the local interconnect, and the other drives the FastTrack Interconnect routing structure. The DATA4 signal can drive the register directly, allowing the LUT to compute a function that is independent of the registered signal; a 3-input function can be computed in the LUT, and a fourth independent signal can be registered. Alternatively, a 4-input function can be generated, and one of the inputs to this function can be used to drive the register. The register in a packed LE can still use the clock enable, clear, and preset signals in the LE. In a packed LE, the register can drive the FastTrack Interconnect routing structure while the LUT drives the local interconnect, or vice versa.

#### Arithmetic Mode

The arithmetic mode offers two 3-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT computes a 3-input function; the other generates a carry output. As shown in Figure 11, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three signals: a, b, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain.

## **Up/Down Counter Mode**

The up/down counter mode offers counter enable, clock enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Two 3-input LUTs are used; one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals without using the LUT resources.

## **Clearable Counter Mode**

The clearable counter mode is similar to the up/down counter mode, but it supports a synchronous clear instead of the up/down control. The clear function is substituted for the cascade-in signal in the up/down counter mode. Two 3-input LUTs are used; one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer. The output of this multiplexer is AND ed with a synchronous clear signal.

## Internal Tri-State Emulation

Internal tri-state emulation provides internal tri-states without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable (OE) signals select which signal drives the bus. However, if multiple OE signals are active, contending signals can be driven onto the bus. Conversely, if no OE signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The Altera software automatically implements tri-state bus functionality with a multiplexer.

## Clear & Preset Logic Control

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE asynchronously loads signals into a register. Either LABCTRL1 or LABCTRL2 can control the asynchronous clear. Alternatively, the register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

During compilation, the compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six modes chosen during design entry:

- Asynchronous clear
- Asynchronous preset
- Asynchronous clear and preset
- Asynchronous load with clear
- Asynchronous load with preset
- Asynchronous load without clear or preset

See Figure 17 for details. I/O Element (IOE) IOF IIOF IOE IOE IOE IOE Row LAB LAB See Figure 16 I AR Interconnect Α1 A2 АЗ for details. Column ►To LAB A5 Interconnect ►To LAB A4 IOE IOE LAB LAB I AR Cascade & B1 R2 В3 Carry Chains To LAB B5 ►To LAB B4 IOE IOE IOE

Figure 14. ACEX 1K Interconnect Resources

## I/O Element

An IOE contains a bidirectional I/O buffer and a register that can be used either as an input register for external data that requires a fast setup time or as an output register for data that requires fast clock-to-output performance. In some cases, using an LE register for an input register will result in a faster setup time than using an IOE register. IOEs can be used as input, output, or bidirectional pins. The compiler uses the programmable inversion option to invert signals from the row and column interconnect automatically where appropriate. For bidirectional registered I/O implementation, the output register should be in the IOE and the data input and output enable registers should be LE registers placed adjacent to the bidirectional pin. Figure 15 shows the bidirectional I/O registers.



For more information, search for "SameFrame" in MAX+PLUS II Help.

Table 10. ACEX 1	Table 10. ACEX 1K SameFrame Pin-Out Support									
Device	256-Pin FineLine BGA	484-Pin FineLine BGA								
EP1K10	✓	(1)								
EP1K30	✓	(1)								
EP1K50	✓	✓								
EP1K100	✓	✓								

#### Note:

 This option is supported with a 256-pin FineLine BGA package and SameFrame migration.

## ClockLock & ClockBoost Features

To support high-speed designs, -1 and -2 speed grade ACEX 1K devices offer ClockLock and ClockBoost circuitry containing a phase-locked loop (PLL) that is used to increase design speed and reduce resource usage. The ClockLock circuitry uses a synchronizing PLL that reduces the clock delay and skew within a device. This reduction minimizes clock-to-output and setup times while maintaining zero hold times. The ClockBoost circuitry, which provides a clock multiplier, allows the designer to enhance device area efficiency by sharing resources within the device. The ClockBoost feature allows the designer to distribute a low-speed clock and multiply that clock on-device. Combined, the ClockLock and ClockBoost features provide significant improvements in system performance and bandwidth.

The ClockLock and ClockBoost features in ACEX 1K devices are enabled through the Altera software. External devices are not required to use these features. The output of the ClockLock and ClockBoost circuits is not available at any of the device pins.

The ClockLock and ClockBoost circuitry lock onto the rising edge of the incoming clock. The circuit output can drive the clock inputs of registers only; the generated clock cannot be gated or inverted.

The dedicated clock pin (GCLK1) supplies the clock to the ClockLock and ClockBoost circuitry. When the dedicated clock pin is driving the ClockLock or ClockBoost circuitry, it cannot drive elsewhere in the device.

## PCI Pull-Up Clamping Diode Option

ACEX 1K devices have a pull-up clamping diode on every I/O, dedicated input, and dedicated clock pin. PCI clamping diodes clamp the signal to the  $V_{\rm CCIO}$  value and are required for 3.3-V PCI compliance. Clamping diodes can also be used to limit overshoot in other systems.

Clamping diodes are controlled on a pin-by-pin basis. When  $V_{\rm CCIO}$  is 3.3 V, a pin that has the clamping diode option turned on can be driven by a 2.5-V or 3.3-V signal, but not a 5.0-V signal. When  $V_{\rm CCIO}$  is 2.5 V, a pin that has the clamping diode option turned on can be driven by a 2.5-V signal, but not a 3.3-V or 5.0-V signal. Additionally, a clamping diode can be activated for a subset of pins, which allows a device to bridge between a 3.3-V PCI bus and a 5.0-V device.

## Slew-Rate Control

The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slower slew rate reduces system noise and adds a maximum delay of 4.3 ns. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate pin-by-pin or assign a default slew rate to all pins on a device-wide basis. The slow slew rate setting affects only the falling edge of the output.

## **Open-Drain Output Option**

ACEX 1K devices provide an optional open-drain output (electrically equivalent to open-collector output) for each I/O pin. This open-drain output enables the device to provide system-level control signals (e.g., interrupt and write enable signals) that can be asserted by any of several devices. It can also provide an additional wired- $\[OR]$  plane.

## MultiVolt I/O Interface

The ACEX 1K device architecture supports the MultiVolt I/O interface feature, which allows ACEX 1K devices in all packages to interface with systems of differing supply voltages. These devices have one set of  $V_{CC}$  pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 2.5-V power supply. With a 2.5-V  $V_{\rm CCINT}$  level, input voltages are compatible with 2.5-V, 3.3-V, and 5.0-V inputs. The VCCIO pins can be connected to either a 2.5-V or 3.3-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 2.5-V power supply, the output levels are compatible with 2.5-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with  $V_{\rm CCIO}$  levels higher than 3.0 V achieve a faster timing delay of  $t_{OD2}$  instead of  $t_{OD1}$ .

Table 13 summarizes ACEX 1K MultiVolt I/O support.

Table 13. ACEX 1K MultiVolt I/O Support												
V <sub>CCIO</sub> (V) Input Signal (V) Output Signal (V)												
	2.5	3.3	5.0	2.5	3.3	5.0						
2.5	<b>✓</b>	<b>√</b> (1)	<b>√</b> (1)	✓								
3.3	<b>✓</b>	<b>✓</b>	<b>√</b> (1)	<b>√</b> (2)	<b>✓</b>	<b>✓</b>						

## Notes:

- (1) The PCI clamping diode must be disabled on an input which is driven with a voltage higher than  $V_{\rm CCIO}$ .
- (2) When  $V_{\rm CCIO}$  = 3.3 V, an ACEX 1K device can drive a 2.5-V device that has 3.3-V tolerant inputs.

Open-drain output pins on ACEX 1K devices (with a pull-up resistor to the 5.0-V supply) can drive 5.0-V CMOS input pins that require a higher  $V_{IH}$  than LVTTL. When the open-drain pin is active, it will drive low. When the pin is inactive, the resistor will pull up the trace to 5.0 V, thereby meeting the CMOS  $V_{OH}$  requirement. The open-drain pin will only drive low or tri-state; it will never drive high. The rise time is dependent on the value of the pull-up resistor and load impedance. The  $I_{OL}$  current specification should be considered when selecting a pull-up resistor.

## Power Sequencing & Hot-Socketing

Because ACEX 1K devices can be used in a mixed-voltage environment, they have been designed specifically to tolerate any possible power-up sequence. The  $V_{\rm CCIO}$  and  $V_{\rm CCINT}$  power planes can be powered in any order.

Signals can be driven into ACEX 1K devices before and during power up without damaging the device. Additionally, ACEX 1K devices do not drive out during power up. Once operating conditions are reached, ACEX 1K devices operate as specified by the user.

Figure 20. ACEX 1K JTAG Waveforms

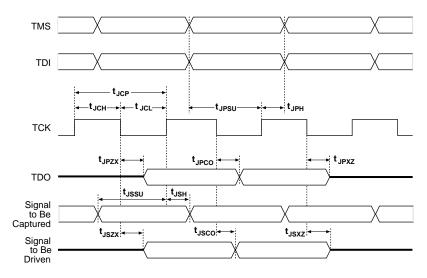


Table 17 shows the timing parameters and values for ACEX 1K devices.

Symbol	Parameter	Min	Max	Unit
t <sub>JCP</sub>	TCK clock period	100		ns
t <sub>JCH</sub>	TCK clock high time	50		ns
t <sub>JCL</sub>	TCK clock low time	50		ns
t <sub>JPSU</sub>	JTAG port setup time	20		ns
t <sub>JPH</sub>	JTAG port hold time	45		ns
t <sub>JPCO</sub>	JTAG port clock to output		25	ns
t <sub>JPZX</sub>	JTAG port high impedance to valid output		25	ns
t <sub>JPXZ</sub>	JTAG port valid output to high impedance		25	ns
t <sub>JSSU</sub>	Capture register setup time	20		ns
t <sub>JSH</sub>	Capture register hold time	45		ns
t <sub>JSCO</sub>	Update register clock to output		35	ns
t <sub>JSZX</sub>	Update register high impedance to valid output		35	ns
t <sub>JSXZ</sub>	Update register valid output to high impedance		35	ns

Table 19	7. ACEX 1K Device Recommended	Operating Conditions			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CCINT</sub>	Supply voltage for internal logic and input buffers	(3), (4)	2.375 (2.375)	2.625 (2.625)	V
V <sub>CCIO</sub>	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V
	Supply voltage for output buffers, 2.5-V operation	(3), (4)	2.375 (2.375)	2.625 (2.625)	V
V <sub>I</sub>	Input voltage	(2), (5)	-0.5	5.75	V
Vo	Output voltage		0	V <sub>CCIO</sub>	V
T <sub>A</sub>	Ambient temperature	Commercial range	0	70	° C
		Industrial range	-40	85	۰C
T <sub>J</sub>	Junction temperature	Commercial range	0	85	۰C
		Industrial range	-40	100	۰C
		Extended range	-40	125	° C
t <sub>R</sub>	Input rise time			40	ns
t <sub>F</sub>	Input fall time			40	ns

Table 2	0. ACEX 1K Device DC Operatin	ng Conditions (Part 1 o	<b>12)</b> Notes (6),	(7)		
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>IH</sub>	High-level input voltage		1.7, 0.5 × V <sub>CCIO</sub> (8)		5.75	V
V <sub>IL</sub>	Low-level input voltage		-0.5		0.8, 0.3 × V <sub>CCIO</sub> (8)	V
V <sub>OH</sub>	3.3-V high-level TTL output voltage	$I_{OH} = -8 \text{ mA DC},$ $V_{CCIO} = 3.00 \text{ V } (9)$	2.4			V
	3.3-V high-level CMOS output voltage	$I_{OH} = -0.1 \text{ mA DC},$ $V_{CCIO} = 3.00 \text{ V } (9)$	V <sub>CCIO</sub> - 0.2			V
	3.3-V high-level PCI output voltage	$I_{OH} = -0.5 \text{ mA DC},$ $V_{CCIO} = 3.00 \text{ to } 3.60 \text{ V}$ (9)	0.9 ׆V <sub>CCIO</sub>			V
	2.5-V high-level output voltage	$I_{OH} = -0.1 \text{ mA DC},$ $V_{CCIO} = 2.375 \text{ V } (9)$	2.1			V
		$I_{OH} = -1 \text{ mA DC},$ $V_{CCIO} = 2.375 \text{ V } (9)$	2.0			V
		$I_{OH} = -2 \text{ mA DC},$ $V_{CCIO} = 2.375 \text{ V } (9)$	1.7			V

Figure 26. ACEX 1K Device IOE Timing Model

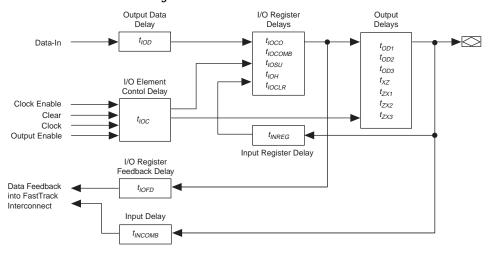
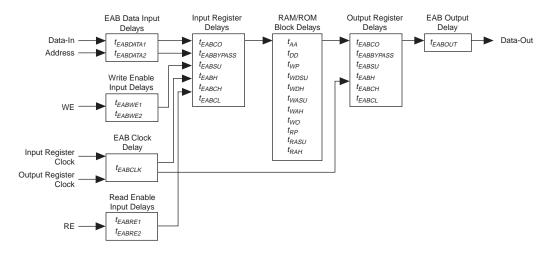


Figure 27. ACEX 1K Device EAB Timing Model



Tables 30 through 36 show EP1K10 device internal and external timing parameters.

Table 30. EP1K10 Device LE Timing Microparameters Note (1)										
Symbol			Speed	Grade			Unit			
	-	1	-	-2		-3				
	Min	Max	Min	Max	Min	Max				
$t_{LUT}$		0.7		0.8		1.1	ns			
$t_{CLUT}$		0.5		0.6		0.8	ns			
t <sub>RLUT</sub>		0.6		0.7		1.0	ns			
t <sub>PACKED</sub>		0.4		0.4		0.5	ns			
$t_{EN}$		0.9		1.0		1.3	ns			
$t_{CICO}$		0.1		0.1		0.2	ns			
t <sub>CGEN</sub>		0.4		0.5		0.7	ns			
t <sub>CGENR</sub>		0.1		0.1		0.2	ns			
t <sub>CASC</sub>		0.7		0.9		1.1	ns			
$t_{C}$		1.1		1.3		1.7	ns			
$t_{\rm CO}$		0.5		0.7		0.9	ns			
t <sub>COMB</sub>		0.4		0.5		0.7	ns			
t <sub>SU</sub>	0.7		0.8		1.0		ns			
t <sub>H</sub>	0.9		1.0		1.1		ns			
t <sub>PRE</sub>		0.8		1.0		1.4	ns			
t <sub>CLR</sub>		0.9		1.0		1.4	ns			
t <sub>CH</sub>	2.0		2.5		2.5		ns			
$t_{CL}$	2.0		2.5		2.5		ns			

Symbol			Speed	Grade			Unit	
	-	1	-;	2	-3			
	Min	Max	Min	Max	Min	Max		
t <sub>DIN2IOE</sub>		2.3		2.7		3.6	ns	
t <sub>DIN2LE</sub>		0.8		1.1		1.4	ns	
t <sub>DIN2DATA</sub>		1.1		1.4		1.8	ns	
t <sub>DCLK2IOE</sub>		2.3		2.7		3.6	ns	
t <sub>DCLK2LE</sub>		0.8		1.1		1.4	ns	
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns	
t <sub>SAMEROW</sub>		1.8		2.1		2.9	ns	
t <sub>SAME</sub> COLUMN		0.3		0.4		0.7	ns	
t <sub>DIFFROW</sub>		2.1		2.5		3.6	ns	
t <sub>TWOROWS</sub>		3.9		4.6		6.5	ns	
t <sub>LEPERIPH</sub>		3.3		3.7		4.8	ns	
t <sub>LABCARRY</sub>		0.3		0.4		0.5	ns	
t <sub>LABCASC</sub>		0.9		1.0		1.4	ns	

Table 35. EP1K10	External Til	ming Param	eters No	te (1)			
Symbol		Unit					
	-	1	-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		7.5		9.5		12.5	ns
t <sub>INSU</sub> (2), (3)	2.4		2.7		3.6		ns
t <sub>INH</sub> (2), (3)	0.0		0.0		0.0		ns
t <sub>оитсо</sub> (2), (3)	2.0	6.6	2.0	7.8	2.0	9.6	ns
t <sub>INSU</sub> (4), (3)	1.4		1.7		_		ns
t <sub>INH</sub> (4), (3)	0.5	5.1	0.5	6.4	-	-	ns
t <sub>оитсо</sub> (4), (3)	0.0		0.0		_		ns
t <sub>PCISU</sub> (3)	3.0		4.2		6.4		ns
t <sub>PCIH</sub> (3)	0.0		0.0		_		ns
t <sub>PCICO</sub> (3)	2.0	6.0	2.0	7.5	2.0	10.2	ns

Table 43. EP1K30	External Bio	directional 1	iming Para	meters No	otes (1), (2)		
Symbol			Speed	Grade			Unit
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>INSUBIDIR</sub> (3)	2.8		3.9		5.2		ns
t <sub>INHBIDIR</sub> (3)	0.0		0.0		0.0		ns
t <sub>INSUBIDIR</sub> (4)	3.8		4.9		-		ns
t <sub>INHBIDIR</sub> (4)	0.0		0.0		-		ns
toutcobidir (3)	2.0	4.9	2.0	5.9	2.0	7.6	ns
t <sub>XZBIDIR</sub> (3)		6.1		7.5		9.7	ns
t <sub>ZXBIDIR</sub> (3)		6.1		7.5		9.7	ns
toutcobidir (4)	0.5	3.9	0.5	4.9	-	-	ns
t <sub>XZBIDIR</sub> (4)		5.1		6.5		-	ns
t <sub>ZXBIDIR</sub> (4)		5.1		6.5		_	ns

#### Notes to tables:

- (1) All timing parameters are described in Tables 22 through 29 in this data sheet.
- (2) These parameters are specified by characterization.
- (3) This parameter is measured without the use of the ClockLock or ClockBoost circuits.
- (4) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

Tables 44 through 50 show EP1K50 device external timing parameters.

Symbol	Speed Grade							
	-1		-2		-3			
	Min	Max	Min	Max	Min	Max		
$t_{LUT}$		0.6		0.8		1.1	ns	
t <sub>CLUT</sub>		0.5		0.6		0.8	ns	
t <sub>RLUT</sub>		0.6		0.7		0.9	ns	
t <sub>PACKED</sub>		0.2		0.3		0.4	ns	
$t_{EN}$		0.6		0.7		0.9	ns	
t <sub>CICO</sub>		0.1		0.1		0.1	ns	
t <sub>CGEN</sub>		0.4		0.5		0.6	ns	
t <sub>CGENR</sub>		0.1		0.1		0.1	ns	
CASC		0.5		0.8		1.0	ns	
$t_{\rm C}$		0.5		0.6		0.8	ns	

Symbol	Speed Grade						
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
$t_{CO}$		0.6		0.6		0.7	ns
t <sub>COMB</sub>		0.3		0.4		0.5	ns
t <sub>SU</sub>	0.5		0.6		0.7		ns
$t_H$	0.5		0.6		0.8		ns
t <sub>PRE</sub>		0.4		0.5		0.7	ns
t <sub>CLR</sub>		0.8		1.0		1.2	ns
t <sub>CH</sub>	2.0		2.5		3.0		ns
$t_{CL}$	2.0		2.5		3.0		ns

Symbol	Speed Grade						
·	_	-1		-2		-3	
	Min	Max	Min	Max	Min	Max	
$t_{IOD}$		1.3		1.3		1.9	ns
t <sub>IOC</sub>		0.3		0.4		0.4	ns
t <sub>IOCO</sub>		1.7		2.1		2.6	ns
t <sub>IOCOMB</sub>		0.5		0.6		0.8	ns
t <sub>IOSU</sub>	0.8		1.0		1.3		ns
t <sub>IOH</sub>	0.4		0.5		0.6		ns
t <sub>IOCLR</sub>		0.2		0.2		0.4	ns
t <sub>OD1</sub>		1.2		1.2		1.9	ns
t <sub>OD2</sub>		0.7		0.8		1.7	ns
t <sub>OD3</sub>		2.7		3.0		4.3	ns
$t_{XZ}$		4.7		5.7		7.5	ns
$t_{ZX1}$		4.7		5.7		7.5	ns
$t_{ZX2}$		4.2		5.3		7.3	ns
$t_{ZX3}$		6.2		7.5		9.9	ns
t <sub>INREG</sub>		3.5		4.2		5.6	ns
t <sub>IOFD</sub>		1.1		1.3		1.8	ns
t <sub>INCOMB</sub>		1.1		1.3		1.8	ns

Symbol	Speed Grade						
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>EABAA</sub>		3.7		5.2		7.0	ns
t <sub>EABRCCOMB</sub>	3.7		5.2		7.0		ns
t <sub>EABRCREG</sub>	3.5		4.9		6.6		ns
t <sub>EABWP</sub>	2.0		2.8		3.8		ns
t <sub>EABWCCOMB</sub>	4.5		6.3		8.6		ns
t <sub>EABWCREG</sub>	5.6		7.8		10.6		ns
t <sub>EABDD</sub>		3.8		5.3		7.2	ns
t <sub>EABDATA</sub> CO		0.8		1.1		1.5	ns
t <sub>EABDATASU</sub>	1.1		1.6		2.1		ns
t <sub>EABDATAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWESU</sub>	0.7		1.0		1.3		ns
t <sub>EABWEH</sub>	0.4		0.6		0.8		ns
t <sub>EABWDSU</sub>	1.2		1.7		2.2		ns
t <sub>EABWDH</sub>	0.0		0.0		0.0		ns
t <sub>EABWASU</sub>	1.6		2.3		3.0		ns
t <sub>EABWAH</sub>	0.9		1.2		1.8		ns
t <sub>EABWO</sub>		3.1		4.3		5.9	ns

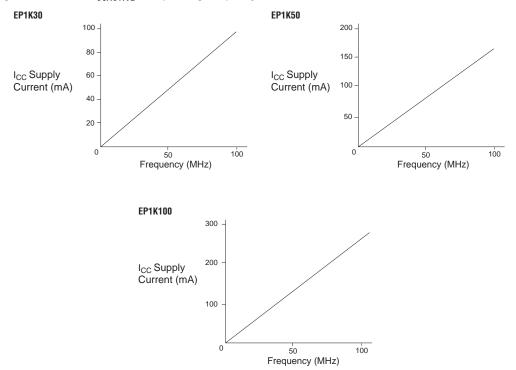


Figure 31. ACEX 1K I<sub>CCACTIVE</sub> vs. Operating Frequency

# Configuration & Operation

The ACEX 1K architecture supports several configuration schemes. This section summarizes the device operating modes and available device configuration schemes.

## Operating Modes

The ACEX 1K architecture uses SRAM configuration elements that require configuration data to be loaded every time the circuit powers up. The process of physically loading the SRAM data into the device is called *configuration*. Before configuration, as  $V_{CC}$  rises, the device initiates a Power-On Reset (POR). This POR event clears the device and prepares it for configuration. The ACEX 1K POR time does not exceed 50  $\mu s$ .



When configuring with a configuration device, refer to the relevant configuration device data sheet for POR timing information.